

(2.00 mm) .0787"

ETMM SERIES

Optional

Locking clips

OTHER

OPTION

Position

-LC

for -RA)

(Manual

-TR

–K

(2.00) .0787

(1.52) 1 .060

(2.29)

-RA

(4.83)

OUDED STRAIN RELIEF IDC HEADER

SPECIFICATIONS

Mates with:

TCSD, TCMD

For complete specifications see www.samtec.com?ETMM

Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze

Phosphor Biolize
Plating:
Sn or Au over
50 µ" (1.27 µm) Ni
Operating Temp Range:
-55 °C to +125 °C
RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.13 mm) .005" max*
*(.004" stencil solution

may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



OTHER SOLUTIONS

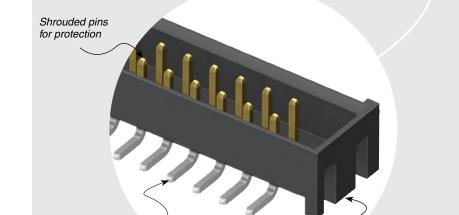
- TCSD mates without Strain Relief. See STMM Series
- Shrouded header for mating with Connector Strips. See LTMM Series

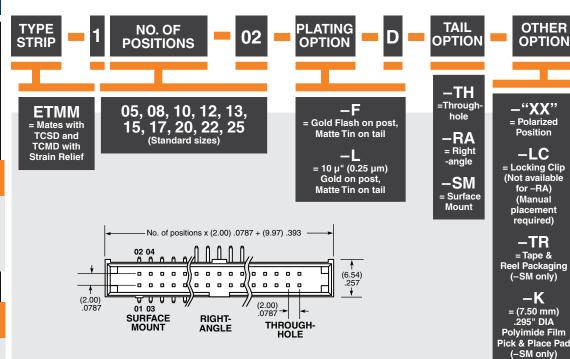
ALSO AVAILABLE (MOQ Required)

(8.00)

· Other sizes Contact Samtec.

Some lengths, styles and options are non-standard, non-returnable.





Surface Mount.

Through-hole and Right-angle